# 3-5353515-0 - ACTIVE

TE Internal #: 3-5353515-0 PCB Mount Header, Vertical, Board-to-Board, 30 Position, .5 mm [. 02 in] Centerline, Gold, Surface Mount, Signal, Black View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: **30** 

Centerline (Pitch): .5 mm [.02 in ]

### Features

#### **Product Type Features**

PCB Connector Assembly Type	PCB Mount Header			
Connector System	Board-to-Board			
Sealable	No			
Connector & Contact Terminates To	Printed Circuit Board			
Configuration Features				
Stackable	Yes			
PCB Mount Orientation	Vertical			
Number of Positions	30			
Board-to-Board Configuration	Parallel			
Electrical Characteristics				
Dielectric Withstanding Voltage (Max)	500 VAC			
Insulation Resistance	2 ΜΩ			
Operating Voltage	250 VAC			
Body Features				
Primary Product Color	Black			

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#### Contact Features

Operating Temperature Range Operation/Application	-30 – 105 °C[-22 – 221 °F]
Housing Temperature Rating	High
Usage Conditions	
Stack Height	1.5 mm[.059 in]
Dimensions	
Housing Material	High heat-resisted resin
Centerline (Pitch)	.5 mm[.02 in]
Connector Mounting Type	Duard Would
PCB Mount Alignment	Board Mount
PCB Mount Alignment	Without
Mating Alignment Type	Keyed
Mating Alignment	With
PCB Mount Retention Type	None
PCB Mount Alignment Type	None
Mechanical Attachment	
Termination Method to Printed Circuit Board	Surface Mount
Rectangular Termination Post & Tail Width	.6 mm[.024 in]
Rectangular Termination Post & Tail Thickness	.15 mm[.006 in]
Fermination Features	
Contact Current Rating (Max)	.3 A
Contact Type	Tab 2 A
	8 μin
Contact Mating Area Plating Material	Gold
Contact Base Material	Copper Alloy
PCB Contact Termination Area Plating Material	Gold
Mating Tab Thickness	.2 mm[.008 in]
Mating Tab Width	.15 mm[.006 in]
Contact Layout	Inline
PCB Contact Termination Area Plating Material Thickness	.05 μm[2 μin]

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Assembly Process Feature	Pick and Place Cover
Circuit Application	Signal
ndustry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	1500
Packaging Type	Tape & Reel
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	
	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	Compliant No Restricted Materials Above Threshold
	No Restricted Materials Above Threshold Current ECHA Candidate List: JUNE 2023
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235)
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE

ppm.

#### Solder Process Capability

Reflow solder capable to 245°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**

PCB Mount Header, Vertical, Board-to-Board, 30 Position, .5 mm [.02 in] Centerline, Gold, Surface Mount, Signal, Black



TE Part # 1-912069-2	TE Part # 316752-2	TE Part # 9-912068-5
COVER TAPE 21.5W	0.5 BTB TAB CONT. AU	EMBOSS TAPE 24W 0.5 FS TAB

# Customers Also Bought



/BOSS,6P		heatsink)	3WT IIK (LECT, 10001 IW), 4A4
TE Part #2204808-8 ELCON MICRO,HEADER,R/A DIP W /BOSS,2P	TE Part #2332485-1 RA REC ASSY 4X4, 920HM PIR WHISPER R		

### Documents

#### **CAD** Files

#### 3D PDF

3D

Customer View Model

#### ENG\_CVM\_CVM\_3-5353515-0\_A.2d\_dxf.zip

English

Customer View Model

ENG\_CVM\_CVM\_3-5353515-0\_A.3d\_igs.zip

English

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#### Customer View Model

#### ENG\_CVM\_CVM\_3-5353515-0\_A.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

#### Datasheets & Catalog Pages

### Fine Pitch Catalog - 0.5mm Fine Stack and Fine Mate Connectors

English

### **Product Specifications**

Product Specification

English

#### **Product Specification**

English

#### Product Environmental Compliance

**Product Compliance** 

English

#### **Product Compliance**

English

#### **Instruction Sheets**

0.5MM F-S CONNECTOR(H 1.5MM) (BOARD TO BOARD SMT TYPE) HANDLING AND OPERATION INSTRUCTION SHEET

English

#### Instruction Sheet (non U.S.)

English